

### Description:

The X4C70L1-03G is a low cost, low profile (0.66mm) sub-miniature (0603) high performance 3 dB hybrid coupler, with a power rating of 3 Watts (AVG) and a peak to average ratio of 12dB, in a new easy to use, Xinger style manufacturing friendly surface mount package. It is designed particularly for 5G (N104), 6G and C-Band applications in all end markets including telecom and COTS Mil-Aero. The X4C70L1-03G is designed particularly for power splitting and combining, where tightly controlled coupling and low insertion loss is required.

Parts have been subjected to rigorous Xinger qualification testing and they are manufactured using materials with coefficients of thermal expansion (CTE) compatible with common substrates such as FR4, RF-35, RO4350 and polyimide. Produced with 6 of 6 RoHS compliant ENIG finish.

### Features:

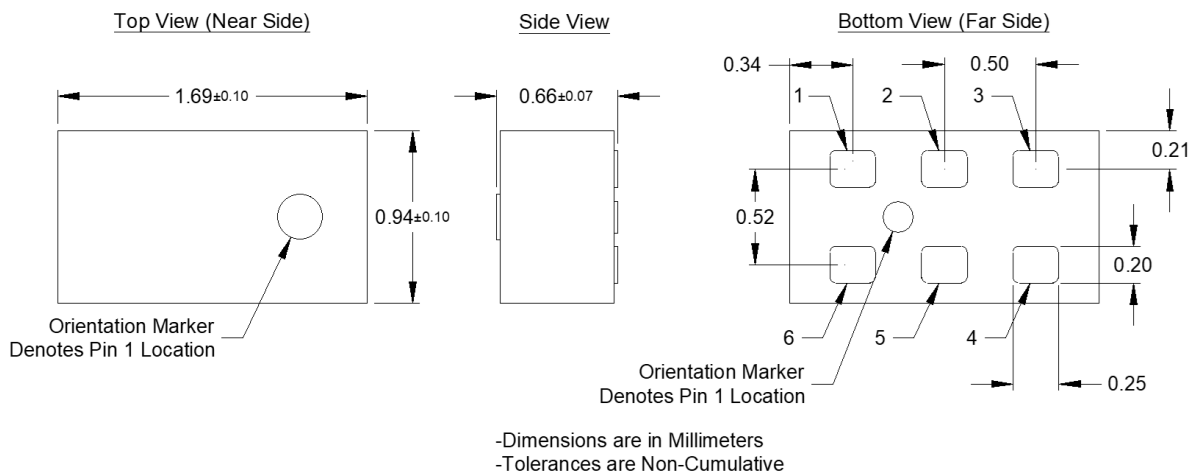
- 5700 to 8400 MHz
- 0.66mm Height Profile
- Power 3W (AVG)
- Peak to Average Ratio of 12dB
- 5G (N104), 6G, C-Band COTS Mil-Aero
- Very Low Loss (<0.3dB)
- High Isolation (>20dB)
- Production Friendly
- Tape and Reel
- Lead Free

### Electrical Specifications\*:

Frequency	Isolation	Return Loss	Amplitude Balance
<i>MHz</i>	<i>dB Min</i>	<i>dB Min</i>	<i>dB Max</i>
5700-8400	20	18	±0.5
Insertion Loss	Phase	Power	Operating Temp.
<i>dB Max</i>	<i>Degrees</i>	<i>Avg. Watts @105°C</i>	<i>°C</i>
0.3	90 ±4	3	-55 to +140

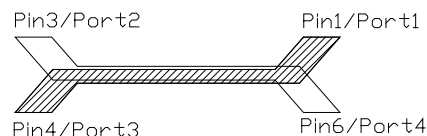
\*Specifications subject to change without notice. Refer to parameter definitions for details. Specification based on performance of unit properly installed on TTM Technologies Test Board with small signal applied.

### Outline Drawing:



## Hybrid Coupler Pin Configuration:

The X4C70L1-03G has an orientation marker to denote Pin 1. Once port one has been identified the other ports are known automatically. Please see the chart below for clarification:

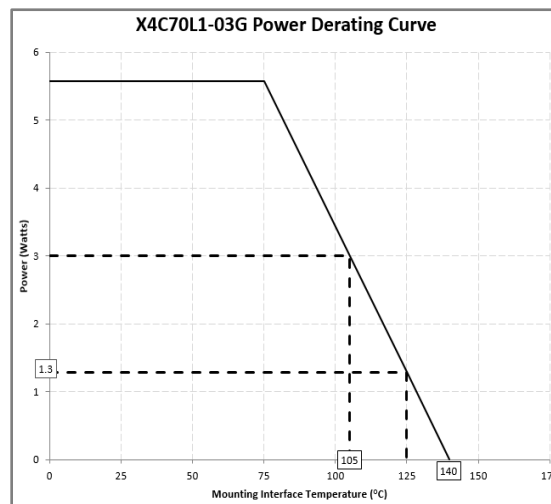
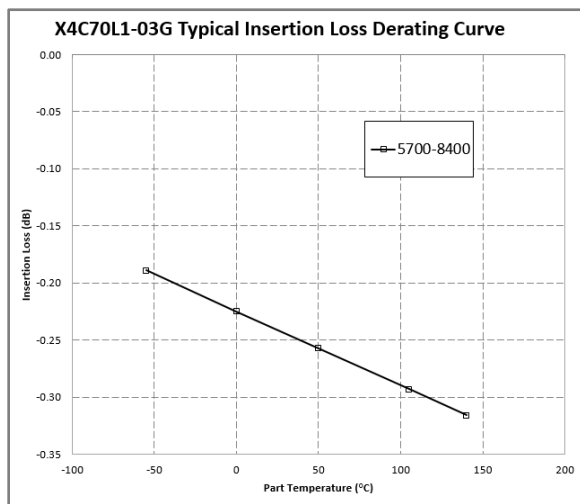


Configuration	Pin1/Port 1	Pin 2	Pin 3/Port2	Pin 4/Port3	Pin 5	Pin 6/Port4
Splitter	Input	GND	Isolated	$-3\text{dB}\angle\theta - 90$	GND	$-3\text{dB}\angle\theta$
Splitter	Isolated	GND	Input	$-3\text{dB}\angle\theta$	GND	$-3\text{dB}\angle\theta - 90$
Splitter	$-3\text{dB}\angle\theta - 90$	GND	$-3\text{dB}\angle\theta$	Input	GND	Isolated
Splitter	$-3\text{dB}\angle\theta$	GND	$-3\text{dB}\angle\theta - 90$	Isolated	GND	Input
*Combiner	$A\angle\theta - 90$	GND	$A\angle\theta$	Isolated	GND	Output
*Combiner	$A\angle\theta$	GND	$A\angle\theta - 90$	Output	GND	Isolated
*Combiner	Isolated	GND	Output	$A\angle\theta - 90$	GND	$A\angle\theta$
*Combiner	Output	GND	Isolated	$A\angle\theta$	GND	$A\angle\theta - 90$

\*Notes: "A" is the amplitude of the applied signals. When two quadrature signals with equal amplitudes are applied to the coupler as described in the table, they will combine at the output port. If the amplitudes are not equal, some of the applied energy will be directed to the isolated port.

The actual phase,  $\angle\theta$  or amplitude at a given frequency for all ports, can be seen in our de-embedded s-parameters that can be downloaded at [www.ttm.com](http://www.ttm.com).

## Insertion Loss and Power Derating Curves:



### Insertion Loss Derating:

The insertion loss, at a given frequency, of the coupler is measured at 25°C and then averaged. The measurements are performed under small signal conditions (i.e. using a Vector Network Analyzer). The process is repeated at -55°C, 105°C and 140°C. A best-fit line for the measured data is computed and then plotted from -55°C to 140°C.

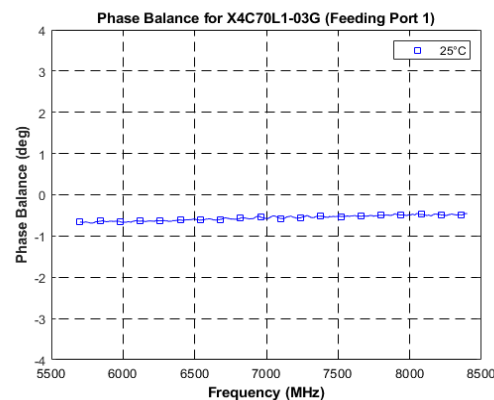
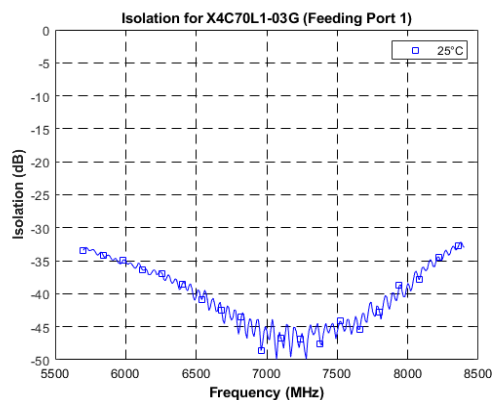
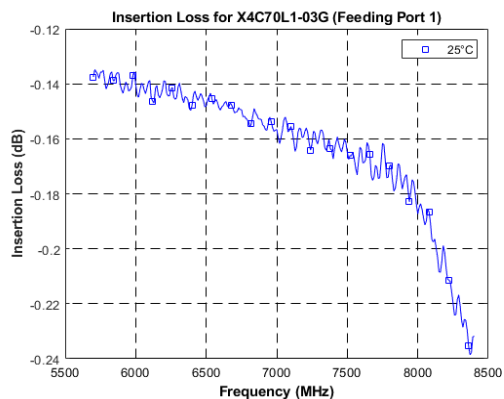
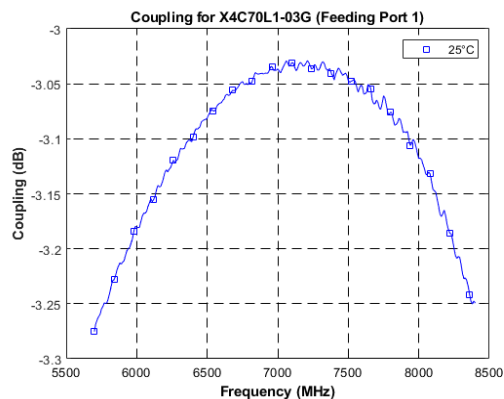
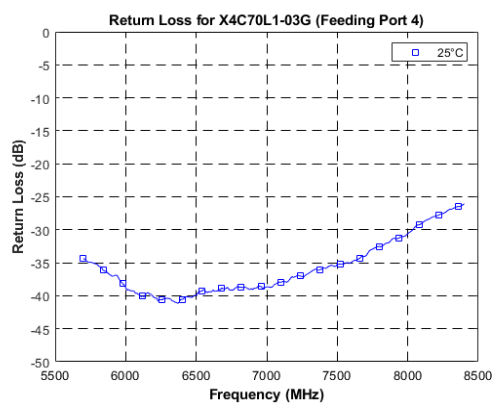
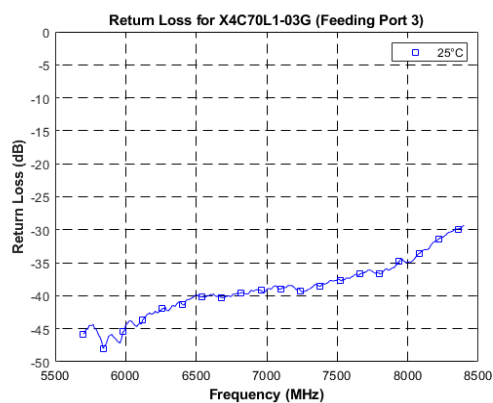
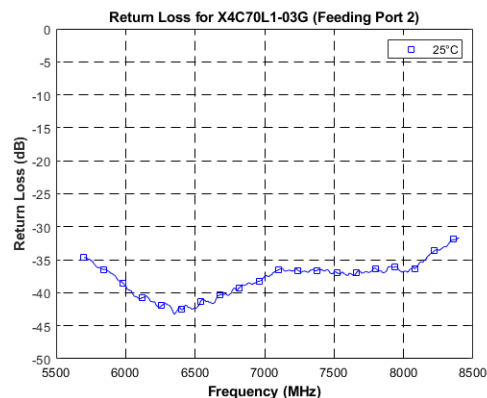
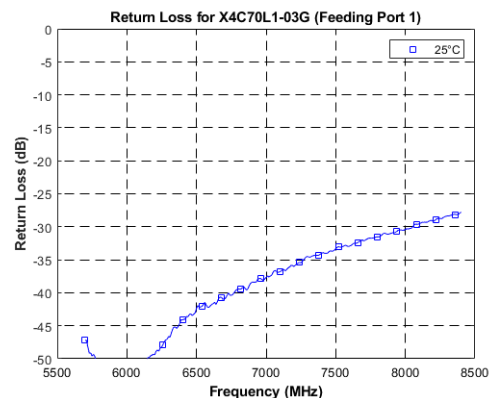
### Power Derating:

The power handling and corresponding power derating plots are a function of the thermal resistance, mounting surface temperature (base plate temperature), maximum continuous operating temperature of the coupler, and the thermal insertion loss. The thermal insertion loss is defined in the Power Handling section of the data sheet.

As the mounting interface temperature approaches the maximum continuous operating temperature, the power handling decreases to zero.

If mounting temperature is greater than 105°C, the Xinger coupler will perform reliably as long as the input power is derated to the curve above.

## Typical Performance: 5700 MHz to 8400 MHz



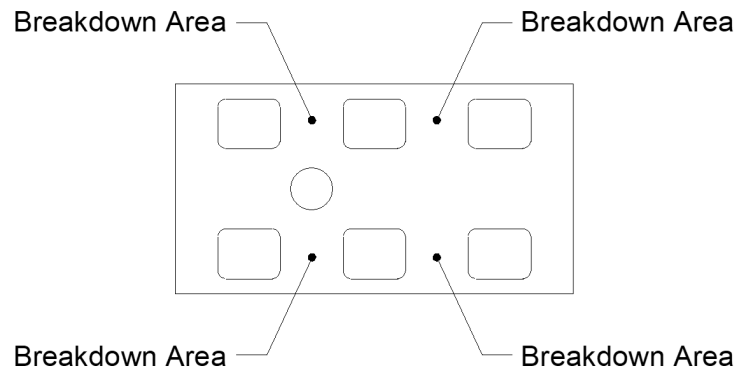
## Definition of Measured Specification:

Parameter	Definition	Mathematical Representation
<b>VSWR</b> (Voltage Standing Wave Ratio)	The impedance match of the coupler to a 50Ω system. A VSWR of 1:1 is optimal.	$VSWR = \frac{V_{max}}{V_{min}}$ <p>Vmax = voltage maxima of a standing wave Vmin = voltage minima of a standing wave</p>
<b>Return Loss</b>	The impedance match of the coupler to a 50Ω system. Return Loss is an alternate means to express VSWR.	$Return\ Loss(dB) = 20\log \frac{VSWR + 1}{VSWR - 1}$
<b>Insertion Loss</b>	The input power divided by the sum of the power at the two output ports.	$Insertion\ Loss(dB) = 10\log \frac{P_{in}}{P_{cpl} + P_{direct}}$
<b>Isolation</b>	The input power divided by the power at the isolated port.	$Isolation(dB) = 10\log \frac{P_{in}}{P_{iso}}$
<b>Amplitude Balance</b>	The power at each output divided by the average power of the two outputs.	$10\log \frac{P_{cpl}}{(P_{cpl} + P_{direct})/2} \text{ and } 10\log \frac{P_{direct}}{(P_{cpl} + P_{direct})/2}$
<b>Phase Balance</b>	The difference in phase angle between the two output ports.	Phase at coupled port – Phase at direct port
<b>Group Delay (GD-C)</b>	Group delay is average of group delay's from input port to the coupled port	Average (GD-C)
<b>Group Delay (GD-DC)</b>	Group delay is average of group delay's from input port to the direct port	Average (GD-DC)

\*100% RF test is performed per spec definition for every pin configuration. Refer to page 2 for pin assignment.

## Peak Power Handling:

High-Pot testing of these components during the qualification procedure resulted in a minimum breakdown voltage of 1Kv (minimum recorded value). This voltage level corresponds to a breakdown resistance capable of handling at least 12dB peak over average power levels, for very short durations. The breakdown location consistently occurred across the pads and the ground pads. The breakdown levels at these points will be affected by any contamination in the gap area around these pads. These areas must be kept clean for optimum performance. It is recommended that the user test for voltage breakdown under the maximum operating conditions and over worst case modulation induced power peaking. This evaluation should also include extreme environmental conditions (such as high humidity).



## Packaging and Ordering Information:

Parts are available in reel and are packaged per EIA 481. Parts are oriented in tape and reel as shown below. Minimum order quantities are 4000 per reel.

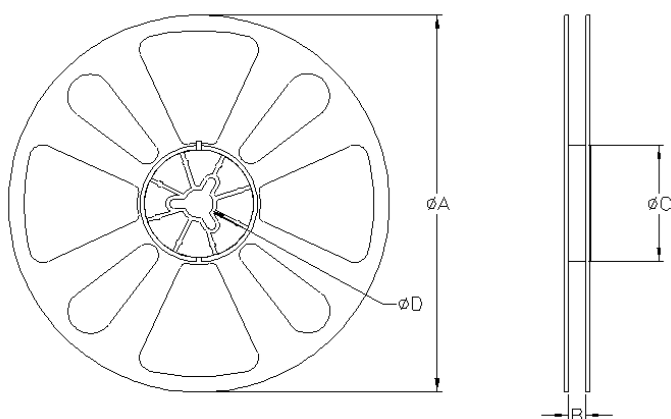
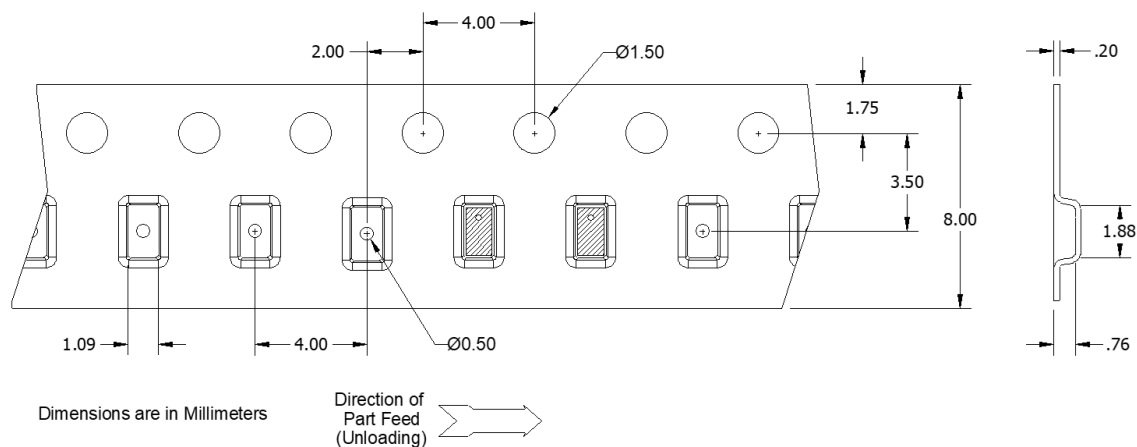


TABLE 1		
QUANTITY/REEL	REEL DIMENSIONS mm	
4000	ØA	177.80
	B	8.00
	ØC	50.80
	ØD	13.00

**Contact us:**  
[rf&s\\_support@ttm.com](mailto:rf&s_support@ttm.com)